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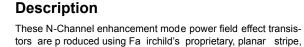
UniFET™

FAIRCHILD SEMICONDUCTOR®

# FDP10N50U / FDPF10N50UT N-Channel MOSFET 500V, 8A, 1.05 $\Omega$

## Features

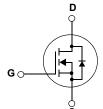
- +  $R_{DS(on)}$  = 0.85 $\Omega$  ( Typ.) @ V<sub>GS</sub> = 10V, I<sub>D</sub> = 4A
- Low Gate Charge (Typ. 18nC)
- Low C<sub>rss</sub> ( Typ. 9pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability
- RoHS Compliant



DMOS technology. This advance technology has been especially tailored to minimize on-state r esistance, provide superior switching per formance and wit bstand high energy pulse in the avalanche and

mize on-state r esistance, prov ide sup erior switching per formance, and wit hstand high energy pulse in the avalanche an d commutation mode. T hese devices are well suited for high efficient switching mode power supplies and active power factor correction.





### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted\*

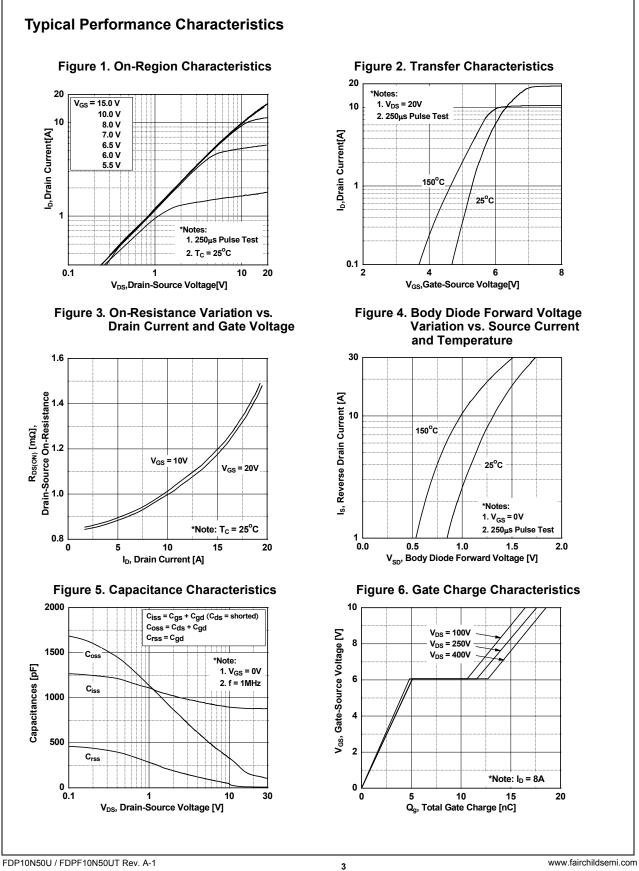
Symbol	Parameter			FDP10N50U	FDPF10N50UT	Units	
V <sub>DSS</sub>	Drain to Source Voltage			500		V	
V <sub>GSS</sub>	Gate to Source Voltage			±30		V	
ID	Drain Current	-Continuous ( $T_C = 25^{\circ}C$ )		8	8*		
		-Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		4.8	4.8*	A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	32	32*	Α	
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	320		mJ	
I <sub>AR</sub>	Avalanche Current		(Note 1)	8		Α	
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	12.5		mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	20		V/ns	
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25 <sup>o</sup> C)		125	42	W	
		- Derate above 25°C		1.0	0.33	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150		°C		
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			3	00	°C	

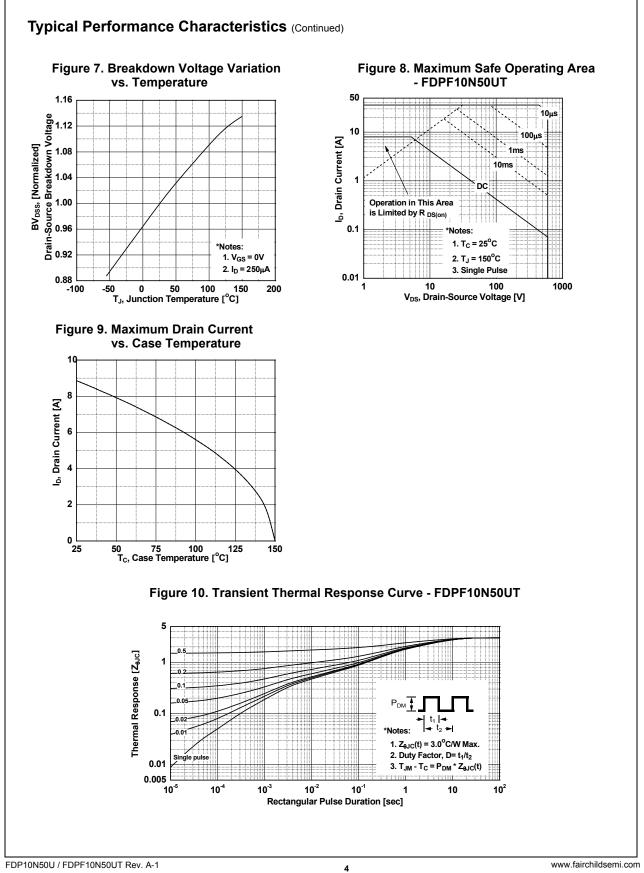
### Thermal Characteristics

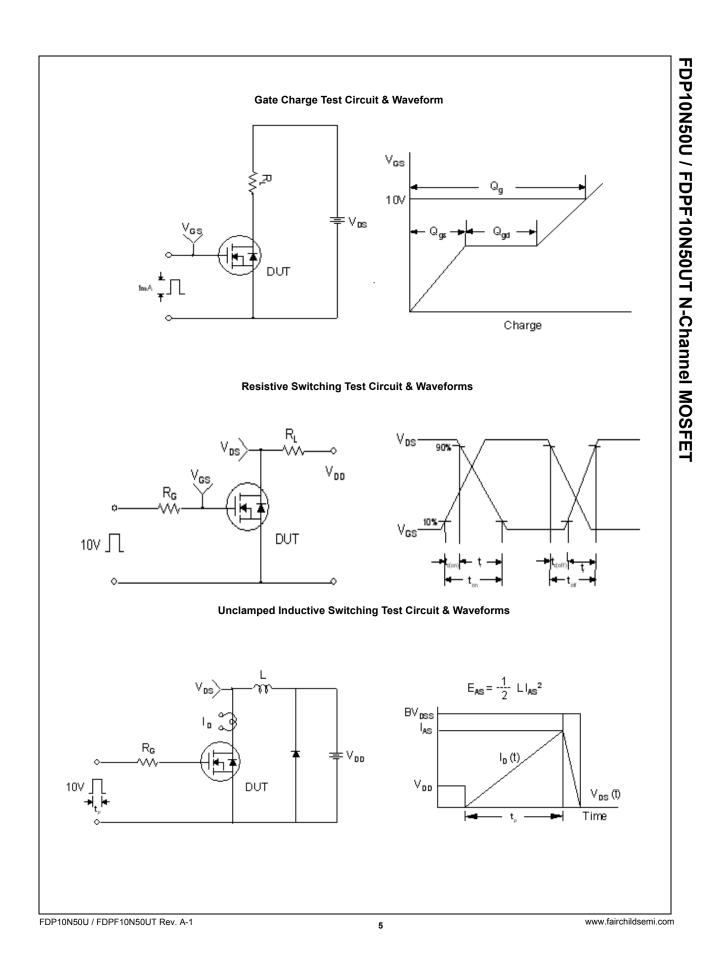
Symbol	Parameter	FDP10N50U	FDPF10N50UT	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.0	3.0	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	C/vv

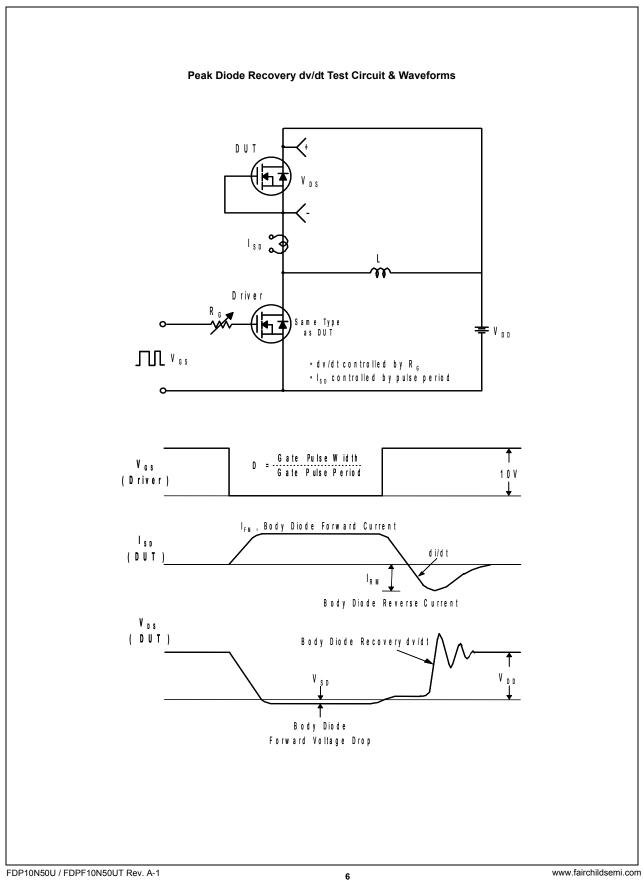
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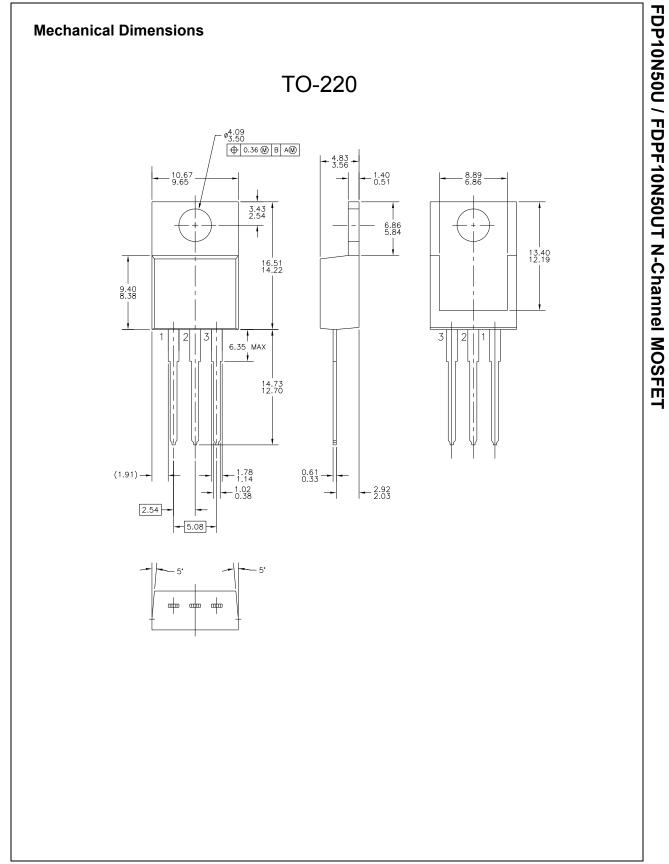
Device Marking		Device Packag		ge Reel Size Tape		e Width		Quantity	
FDP10N50U FDP10N50U TO-22		FDP10N50U	TO-220	-		-		50	
		TO-220F	-		-		50		
Electrica	I Chai	racteristics							
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Units
Off Charac	teristic	s							
BV <sub>DSS</sub>	Drain t	o Source Breakdown V	oltage I <sub>D</sub> = 2	250μA, V <sub>GS</sub> = 0V, T <sub>J</sub> =	= 25°C	500	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakd	Breakdown Voltage Temperature		$I_D = 250 \mu A$ , Referenced to $25^{\circ}C$		-	0.6	-	V/ºC
Δij	Coemic	Jent	V <sub>D</sub> e :	V <sub>DS</sub> = 500V, V <sub>GS</sub> = 0V		-	-	25	
I <sub>DSS</sub>	Zero G	ate Voltage Drain Curre		= 400V, T <sub>C</sub> = 125°C		-	-	250	μA
I <sub>GSS</sub>	Gate to	Body Leakage Curren		$V_{GS} = \pm 30V, V_{DS} = 0V$			-	±100	nA
On Charac	teristic	s							
V <sub>GS(th)</sub>	T	hreshold Voltage	Vce	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA			-	5.0	V
R <sub>DS(on)</sub>		Drain to Source On Res		= 10V, I <sub>D</sub> = 4A		3.0	0.85	1.05	Ω
9FS	Forwar	rd Transconductance		$V_{DS} = 20V, I_D = 4A \qquad (Note 4)$			8.5	-	S
Dynamic C	haract	orietice	·						
	1					-	850	1130	pF
C <sub>oss</sub>		put Capacitance verse Transfer Capacitance		−V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V − f = 1MHz		-	115	155	pF
C <sub>rss</sub>						-	9	13.5	pF
Q <sub>g</sub>		I Gate Charge at 10V e to Source Gate Charge e to Drain "Miller" Charge		$V_{DS} = 400V, I_D = 10A$ $V_{GS} = 10V$ (Note 4, 5)		-	18	24	nC
Q <sub>gs</sub>						-	5	-	nC
Q <sub>gd</sub>	Gate to					-	7.5	-	nC
Switching	Charac	toriction			(				
-	1	n Delay Time				_	15	40	ns
t <sub>d(on)</sub> t <sub>r</sub>		n Rise Time	Vnn	V <sub>DD</sub> = 250V, I <sub>D</sub> = 10A		_	38	86	ns
t <sub>d(off)</sub>		Irn-Off Delay Time		$R_{G} = 25\Omega, V_{GS} = 10V$			46	102	ns
t <sub>f</sub>		ff Fall Time		(Note 4, 5)			33	76	ns
Drein Cour		de Chevesterietie	•			ļ		Į	1
	-	de Characteristic	_	and Current				0	٨
I <sub>S</sub>	Maximum Continuous Drain to Source Dioo Maximum Pulsed Drain to Source Diode Fo					-	-	8 32	A
I <sub>SM</sub> V <sub>SD</sub>		Source Diode Forward				-	-	1.6	V
<u>vs</u> t <sub>rr</sub>		e Recovery Time		$\begin{array}{c c} tage & V_{GS} = 0V, \ I_{SD} = 8A \\ \hline & V_{GS} = 0V, \ I_{SD} = 8A \\ \hline & dI_{F}/dt = 100A/\mu s & (Note 4) \end{array}$		-	44	-	ns
Q <sub>rr</sub>		e Recovery Charge				-	45	-	nC
2: L = 10mH, I <sub>AS</sub> : 3: I <sub>SD</sub> ≤ 8A, di/dt 4: Pulse Test: Pul	= 8A, V <sub>DD</sub> = ≤ 200A/μs, \ lse width ≤ 3	dth limited by maximum junctio 50V, $R_G$ = 25 $\Omega$ , Starting $T_J$ = 2 $f_{DD} \leq BV_{DSS}$ , Starting $T_J$ = 25° Odµs, Duty Cycle $\leq 2\%$ Operating Temperature Typica	25°C C						







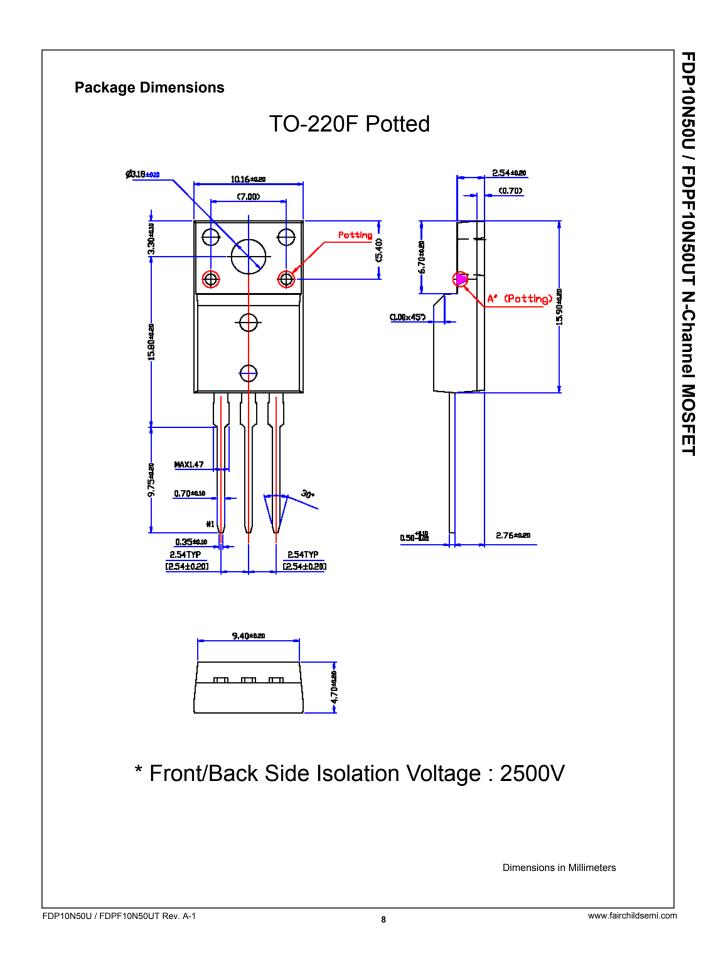




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